

MCUXSDKRDRW61XRN

MCUXpresso SDK Release Notes for RD-RW61X

Rev. 2.16.100 — 23 September 2024

Release notes

Document information

Information	Content
Keywords	MCUXSDKRDRW61XRN, RD-RW61X, Release Notes
Abstract	This document describes the MCUXpresso SDK Release Notes for RD-RW61X.



1 Overview

The MCUXpresso SDK is a comprehensive software enablement package designed to simplify and accelerate application development with Arm Cortex-M-based devices from NXP, including its general purpose, crossover and Bluetooth-enabled MCUs. MCUXpresso SW and Tools for DSC further extends the SDK support to current 32-bit Digital Signal Controllers. The MCUXpresso SDK includes production-grade software with integrated RTOS (optional), integrated enabling software technologies (stacks and middleware), reference software, and more.

In addition to working seamlessly with the MCUXpresso IDE, the MCUXpresso SDK also supports and provides example projects for IAR, KEIL, and GCC with Cmake. Support for the MCUXpresso Config Tools allows easy cloning of existing SDK examples and demos, allowing users to leverage the existing software examples provided by the SDK for their own projects.

Underscoring our commitment to high quality, the MCUXpresso SDK is MISRA compliant and checked with Coverity static analysis tools. For details on MCUXpresso SDK, see [MCUXpresso-SDK: Software Development Kit for MCUXpresso](#).

2 MCUXpresso SDK

As part of the MCUXpresso software and tools, MCUXpresso SDK is the evolution of Kinetis SDK, includes support for LPC, DSC, and i.MX System-on-Chip (SoC). The same drivers, APIs, and middleware are still available with support for Kinetis, LPC, DSC, and i.MX silicon. The MCUXpresso SDK adds support for the MCUXpresso IDE, an Eclipse-based toolchain that works with all MCUXpresso SDKs. Easily import your SDK into the new toolchain to access to all of the available components, examples, and demos for your target silicon. In addition to the MCUXpresso IDE, support for the MCUXpresso Config Tools allows easy cloning of existing SDK examples and demos, allowing users to leverage the existing software examples provided by the SDK for their own projects.

In order to maintain compatibility with legacy Freescale code, the filenames and source code in MCUXpresso SDK containing the legacy Freescale prefix FSL has been left as is. The FSL prefix has been redefined as the NXP Foundation Software Library.

3 Development tools

The MCUXpresso SDK is compiled and tested with these development tools:

- Keil MDK, version is 5.4.
- MCUXpresso IDE, version is 11.10.0_3148.
- GCC Arm Embedded, version is 13.2.1.
- IAR Embedded Workbench for Arm, version is 9.60.2.

4 Supported development system

This release supports boards and devices listed in table below. The boards and devices in bold were tested in this release.

Note: A1 samples are no longer supported in MCUXpresso SDK 2.16.000 release.

Table 1. Supported boards and devices

Development boards	MCU devices
RD-RW612-BGA	RW612ETA2I , RW612HNA2I, RW612UKA2I, RW610ETA2I, RW610HNA2I, RW610UKA2I

5 MCUXpresso SDK release package

The MCUXpresso SDK release package content is aligned with the silicon subfamily it supports. This includes the boards, devices, documentation, and middleware.

5.1 Device support

The device folder contains the whole software enablement available for the specific System-on-Chip (SoC) subfamily. This folder includes clock-specific implementation, device register header files, device register feature header files, and the system configuration source files. Included with the standard SoC support are folders containing peripheral drivers, toolchain support, and a standard debug console. The device-specific header files provide a direct access to the microcontroller peripheral registers. The device header file provides an overall SoC memory mapped register definition. The folder also includes the feature header file for each peripheral on the microcontroller. The toolchain folder contains the startup code and linker files for each supported toolchain. The startup code efficiently transfers the code execution to the `main()` function.

5.1.1 Board support

The boards folder provides the board-specific demo applications, driver examples, and middleware examples.

5.1.2 Demo application and other examples

The demo applications demonstrate the usage of the peripheral drivers to achieve a system level solution. Each demo application contains a readme file that describes the operation of the demo and required setup steps. The driver examples demonstrate the capabilities of the peripheral drivers. Each example implements a common use case to help demonstrate the driver functionality.

5.2 CMSIS DSP Library

The MCUXpresso SDK is shipped with the standard CMSIS development pack, including the prebuilt libraries.

5.3 Operating System

5.3.1 FreeRTOS

Real-time operating system for microcontrollers from Amazon.

5.4 Middleware

5.4.1 cJSON

Ultra lightweight JSON parser in ANSI C.

5.4.2 Fatfs

The FatFs file system is integrated with the MCUXpresso SDK and can be used to access either the SD card or the USB memory stick when the SD card driver or the USB Mass Storage Device class implementation is used.

5.4.3 LittleFS

A little fail-safe filesystem designed for microcontrollers.

5.4.4 LVGL

Light and Versatile Graphics Library.

5.4.5 lwIP

The lwIP TCP/IP stack is pre-integrated with MCUXpresso SDK and runs on top of the MCUXpresso SDK Ethernet driver with Ethernet-capable devices/boards.

For details, see the *lwIP TCP/IP Stack and MCUXpresso SDK Integration User's Guide* (document MCUXSDKLWIPUG).

5.4.6 Maestro Audio Framework for MCU

Maestro Audio Framework library for MCU.

5.4.7 Mbed Crypto

Mbed Crypto library.

5.4.8 mbedTLS

mbdttls SSL/TLS library.

5.4.9 MCUBoot

A bootloader for microcontrollers.

5.4.10 NXP Wi-Fi

The MCUXpresso SDK provides driver for NXP Wi-Fi external modules. The Wi-Fi driver is integrated with LWIP TCP/IP stack and demonstrated with several network applications (iperf and AWS IoT).

For more information, see *Getting Started with NXP based Wireless Modules and i.MX RT Platform Running on RTOS* (document: UM11441).

5.4.11 TF-M

Trusted Firmware - M Library.

5.4.12 USB Host, Device, OTG Stack

See the MCUXpresso SDK USB Stack User's Guide (document MCUXSDKUSBSUG) for more information.

5.4.13 Wireless EdgeFast Bluetooth PAL

For more information, see the MCUXpresso SDK EdgeFast Bluetooth Protocol Abstraction Layer User's Guide.

6 Release contents

[Table 2](#) provides an overview of the MCUXpresso SDK release package contents and locations.

Table 2. MCUXpresso SDK release package contents and locations

Deliverable	Location
Boards	INSTALL_DIR/boards
Demo Applications	INSTALL_DIR/boards/<board_name>/demo_apps
Driver Examples	INSTALL_DIR/boards/<board_name>/driver_examples
Board Project Template for MCUXpresso IDE NPW	INSTALL_DIR/boards/<board_name>/project_template
Driver, SoC header files, extension header files and, feature header files, utilities	INSTALL_DIR/devices/<device_name>
Peripheral drivers	INSTALL_DIR/devices/<device_name>/drivers
Toolchain linker files and startup code	INSTALL_DIR/devices/<device_name>/<toolchain_name>
Utilities such as debug console	INSTALL_DIR/devices/<device_name>/utilities
Device Project Template for MCUXpresso IDE NPW	INSTALL_DIR/devices/<device_name>/project_template
CMSIS Arm Cortex-M header files, DSP library source	INSTALL_DIR/CMSIS
Components and board device drivers	INSTALL_DIR/components
RTOS	INSTALL_DIR/rtos
Release Notes, Getting Started Document and other documents	INSTALL_DIR/docs
Tools such as shared cmake files	INSTALL_DIR/tools

7 MISRA compliance

All MCUXpresso SDK drivers comply to MISRA 2012 rules with exceptions in [Table 3](#).

Table 3. MISRA exception rules

Exception rules	Description
Directive 4.4	Sections of code should not be commented out.
Directive 4.5	Identifiers in the same name space with overlapping visibility should be typographically unambiguous.
Directive 4.6	Typedefs that indicate size and signedness should be used in place of the basic numerical types.
Directive 4.8	If a pointer to a structure or union is never dereferenced within a translation unit, then the implementation of the object should be hidden.
Directive 4.9	A function should be used in preference to a function-like macro where they are interchangeable.
Directive 4.13	Functions which are designed to provide operations on a resource should be called in an appropriate sequence.
Rule 1.2	Language extensions should not be used.
Rule 2.3	A project should not contain unused type declarations.
Rule 2.4	A project should not contain unused tag declarations.

Table 3. MISRA exception rules...continued

Exception rules	Description
Rule 2.5	A project should not contain unused macro declarations.
Rule 2.6	A function should not contain unused label declarations.
Rule 2.7	There should be no unused parameters in functions.
Rule 4.2	Trigraphs should not be used.
Rule 5.1	External identifiers shall be distinct.
Rule 5.4	Macro identifiers shall be distinct.
Rule 5.9	Identifiers that define objects or functions with internal linkage should be unique.
Rule 8.7	Functions and objects should not be defined with external linkage if they are referenced in only one translation unit.
Rule 8.9	An object should be defined at block scope if its identifier only appears in a single function.
Rule 8.11	When an array with external linkage is declared, its size should be explicitly specified.
Rule 8.13	A pointer should point to a const-qualified type whenever possible.
Rule 10.5	The value of an expression should not be cast to an inappropriate essential type.
Rule 11.4	A conversion should not be performed between a pointer to object and an integer type.
Rule 11.5	A conversion should not be performed from pointer to void into pointer to object.
Rule 12.1	The precedence of operators within expressions should be made explicit.
Rule 12.3	The comma operator should not be used.
Rule 12.4	Evaluation of constant expressions should not lead to unsigned integer wrap-around.
Rule 13.3	A full expression containing an increment (++) or decrement (–) operator should have no other potential side effects other than that caused by the increment or decrement operator.
Rule 15.4	There should be no more than one break or go to statement used to terminate any iteration statement.
Rule 17.5	The function argument corresponding to a parameter declared to have an array type shall have an appropriate number of elements.
Rule 17.8	A function parameter should not be modified.
Rule 19.2	The union keyword should not be used.
Rule 20.1	#include directives should only be preceded by preprocessor directives or comments.
Rule 20.10	The # and ## preprocessor operators should not be used.
Rule 21.1	#define and #undef shall not be used on a reserved identifier or reserved macro name.

Table 3. MISRA exception rules...continued

Exception rules	Description
Rule 21.2	A reserved identifier or macro name shall not be declared.
Rule 21.12	The exception handling features of <env.h> should not be used.

8 Known issues

This section lists the known issues, limitations, and/or workarounds.

8.1 New Project Wizard compile failure

The following components request the user to manually select other components that they depend upon in order to compile.

These components depend on several other components and the New Project Wizard (NPW) is not able to decide which one is needed by the user.

Components: wireless_framework_lfs_config, sdu_adapter, and sdu.

Note: Most of middleware components have complex dependencies and are not fully supported in new project wizard. Adding a middleware component may result in compile failure.

8.2 SDK does not fully support the MCUX Config Tool

Currently, the pin/clock config files in the MCUXpresso SDK are not generated from the MCUXpresso Config Tool. As a result, there is an error reported during project import/clone from the SDK package. However, the Config Tool itself can work without any issue.

8.3 Cloned project cannot build issue

Some cloned projects cannot build due to missing dependent component configuration. To fix the issue, you must correct the configuration manually in the cloned project.

The failed projects include nbu_bb_bm, wifi_cli_over_ble_wu, and ncp_device.

8.4 Maximum file path length in Windows 7 operating system

The Windows 7 operating system imposes a 260-character maximum length for file paths. When installing the MCUXpresso SDK, place it in a directory close to the root to prevent file paths from exceeding the maximum character length specified by the Windows operating system. The recommended location is the C:\<folder>.

8.5 Romapi_flexspi example not working

The romapi_flexspi example fails to work with armgcc flash_debug target.

8.6 No UART simulated for hello_world_virtual_com

No UART peripheral is simulated for hello_world_virtual_com after downloading.

8.7 Limitations when creating a new FreeRTOS-based C/C++ project

Due to the missing component dependencies definition, there are several limitations when creating a new FreeRTOS-based C/C++ project in MCUXpresso IDE. When the **FreeRTOS kernel** component is selected (under Operating Systems/RTOS/Core menu), you must manually select the **FreeRTOS cm33 non trustzone port** component (under Middleware/RTOS menu) for projects without TrustZone. For FreeRTOS TrustZone projects creation, the support is not ready.

8.8 GPIO toggle operation not working on NCP SPI slave side with flash release build

Due to IDE compile optimization for the flash release target, the GPIO toggle operation on the NCP SPI slave side to indicate RX DMA ready or slave to master transfer is not working. The issue occurs because the GPIO toggle time is too short for the host to detect it.

8.9 El2go_agent_demo_wifi issue

The `el2go_agent_demo_wifi` project does not work on MCUXpresso for VSCode. However, Arm GCC standalone, MCUXpresso IDE, MDK, or IAR have no limitations.

Note: *The above issue is not really a limitation of the SDK release, as it gets fixed by a toolchain update. The issue also partially applies to all other examples using TF-M.*

When using MCUX IDE, do not specify a custom prefix or suffix while importing the example.

However, if it is a custom prefix or suffix is added, you must adapt the names of the library projects `el2go_mbedtls_lib` and `el2go_tfm_psa_ns_lib` in the `el2go_agent_demo_wifi_ns` project. To change the linker import paths to the right name, select **Project settings > C/C++ Build > Settings > MCU linker > Miscellaneous > Other Objects**.

Note: *This limitation stays as it depends on the SDK generator fixes.*

9 Change log

Change log of software components included in the package, see MCUXpresso SDK ChangeLog_RW610.pdf.

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